

Improved thermal removal from Nb-Ti SC cables



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We are modeling *steady-state* heat transfer from SC Rutherford cable to an *isothermal* He II bath.

We profit of previous measurements done mostly at CEA-Saclay on different cable insulation schemes.

We show there is a potential for a large margin of improvement of heat removal with respect to present LHC schemes



Cable insulation





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For a LHC main dipole : Inner cable perimeter ~ 12 cm For $\Delta T = 150 \text{ mK} \Rightarrow Q = 85 \text{ W/m}^2$ $\downarrow\downarrow$ Heat transfer ~ 165 mW/m per turn IF UNIFORMELY DISTRIBUTED ~10 W/m per aperture

Elaborated from B. Baudouy et al Cryogenics 39, 921 (1999)



Assumptions:

- Negligible thermal boundary resistance at the strand-insulation interface [3,4]
- Parallel paths are decoupled
- Conductor and He II bath are isothermal
- He II heat transfer regime is Gorter-Mellink [5] (may lead to under-estimate [6]).



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Enhanced Porosity







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- We show the radial flow rate versus the imposed pressure difference ($\Delta P = P_{inlet} P_{outlet}$).
- Porosity of enhanced insulation is one order of magnitude larger both at 10 and at 50 MPa vertical compression



Vertical compression: 10 MPa

Vertical compression: 10-16-50 MPa

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Courtesy of D. Richter (CERN)

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• The present limitation of heat removal from state of the art insulated NbTi Rutherford cables at 1.9 K is about 85 W/m², corresponding to about 165 mW/m for a LHC main dipole turn.

• There is a large potential to increase the dimension of the cooling channels thus moving their saturation at higher heat fluxes

This opens new opportunities for using NbTi rutherford cables in costeta structures operating at 1.9 K in presence of heat loads

CERN	Coming soon
CARE	THERMOMAG-07 Image: Complete Sectors A CARE-HHH Workshop on Sectors Heat Generation & Transfer in Superconducting Magnets Paris, 19-20 November 2007
Workshop leaflet Timetable	LPNHE – Université Pierre & Marie Curie (Paris VI) 4, Place Jussieu – 75006 Paris Tour 33 – Amphithéâtre Bernard Grossetête
Registration Information for authors List of participants List of hotels How to get there	 Minimizing and evacuating heat is one of the main challenges of the next generation of superconducting magnets for high intensity particle accelerators, such as the IR magnet for the LHC luminosity upgrade and the fast cycled magnets for FAIR and for the LHC injector chain upgrade. This workshop aims at reviewing the present knowledge on heat transfer in superconducting magnets, and at identifying common thermal design bases. Expected outputs are: identify the state of the art on Cooling techniques (fluids and regimes) Heat transfer mechanisms Identify a common set of thermal design criteria Organizing Committee E. B. Baudouy, D. Tommasini, B. Piccirelli Scientific secretary : H. Allain, M. La China







Thermal boundary resistance at interfaces between different materials (Kapitza):

We use empirical fits $q\;[W/m^2]$,T [K],

- → Cu-He II: $q = 460(T_{Cu}^{3.46} T_{He}^{3.46})$, [7]
- → Kapton-He II: $q = 47.43(T_{Kap}^{4} T_{He}^{4})$, [8] verified for small ΔT , we use it also for epoxy
- → Cu-epoxy: $q = 1300_{2K} \div 3600_{6K} (T_{Cu} T_{Ep})$, [2] consistent with [3]

Conduction in solids:

- ✤ Kapton: K=4.638e-3*T.^0.5678 [8] verified for 0.5<T<5K</p>
- → Epoxy+fiberglass: $K = 0.6*K_{Ep}+0.4*K_{G10}$, ($K_{Ep} \notin K_{G10}$ from [9] consistent with [3] and [10])
- He II thermal conductivity

We consider a fully developed Gorter-Mellink regime [4] (conservative hypotheses [5])







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